

Specification Page 21 - Amended without Underlining
And Strikethroughs - Clean Version

to each other are selected. These purposes are to prevent thermal deterioration of the material due to excessive heating during heat sealing and to achieve an improvement in operational efficiency.

There are no particular limitations for the bundling portion 40 constituting the bundling portion of the filaments 30 regarding the place, configuration, and number thereof. For example, when connecting together the filaments 30 impregnated with adhesive, the bundling portion 40 has a predetermined width. In the case of connection by heat sealing, the linear bundling portion 40 is generally provided in a direction crossing the filaments. However, there is no need for all the filaments 30 constituting the filament bundling body 31 to be integrally connected by one bundling portion 40; it is also possible for the whole to be connected by two or more bundling portions 40. That is, as long as all the filaments 30 are connected with any of the other filaments 30 and not separated from the filament bundling body 31, the bundling portion 40 may be, for example, of a construction in which a plurality of short linear bundling portions crossing the filaments 30 are provided in a zigzag

fashion.

Fig. 6 is an exploded perspective view of a cleaning device according to a second embodiment of the present invention. Reference numeral 6 indicates a base material sheet, reference numeral 20 indicates a main cleaning portion, and reference numeral 50 indicates an adhesive. A large number of filaments 30 aligned in the fiber